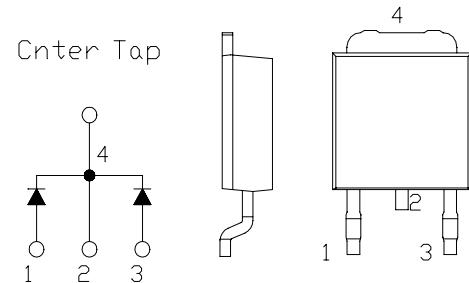


SBD Type : EA60QC04-F

OUTLINE DRAWING

FEATURES

- * TO-252AA Case, Surface Mount Device
- * Dual Diodes Cathode Common
- * Low Forward Voltage drop
- * Low Power Loss
- * High Surge Capability
- * 30 Volts thru 100 Volts Types Available
- * Packaged in 16mm Tape and Reel



Maximum Ratings

Approx Net Weight: 0.30g

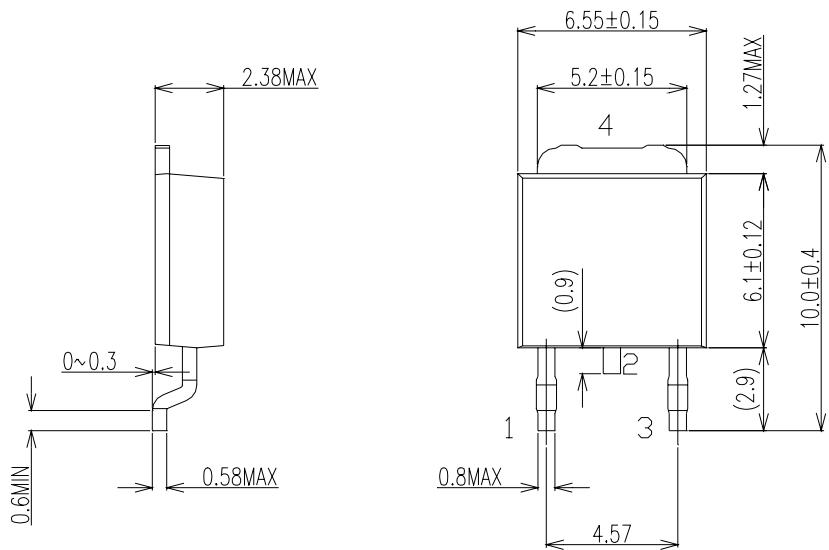
Rating	Symbol	EA60QC04-F				Unit					
Repetitive Peak Reverse Voltage	V_{RRM}	40				V					
Non-repetitive Peak Reverse Voltage	V_{RSM}	45				V					
Average Rectified Output Current	I_o	2.0	Ta=21°C	50Hz Full Sine Wave Resistive Load		A					
		6.0	Tc=118°C								
RMS Forward Current	$I_{F(RMS)}$	6.66				A					
Surge Forward Current	I_{FSM}	45	50Hz Full Sine Wave, 1cycle, Non-repetitive			A					
Operating JunctionTemperature Range	T_{jw}	- 40 to + 150				°C					
Storage Temperature Range	T_{stg}	- 40 to + 150				°C					

Electrical • Thermal Characteristics

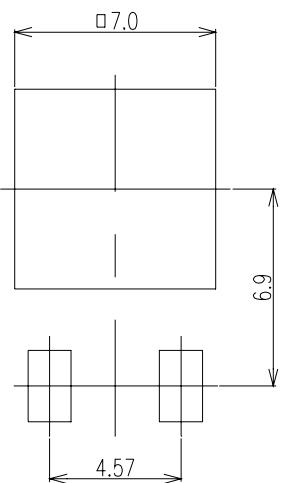
Characteristics		Symbol	Conditions	Min	Typ	Max	Unit
Peak Reverse Current	I_{RM}	$T_j=25^\circ C, V_{RM}=V_{RRM}$ per Arm	-	-	3.0	mA	
Peak Forward Voltage	V_{FM}	$T_j=25^\circ C, I_{FM}= 3A$ per Arm	-	-	0.55	V	
Thermal Resistance	Junction to Ambient	$R_{th(j-a)}$	P.C.Board mounted *	-	-	80	°C/W
	Junction to Case	$R_{th(j-c)}$	-	-	-	5	°C/W

* Print Land = 20x20 mm

EA60QC04-F OUTLINE DRAWING (Dimensions in mm)



SOLDERING PAD



Center Tap

